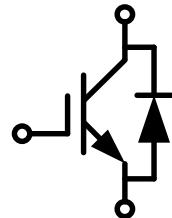


IGBT Discrete with Anti-Parallel Diode

电气特性:

- 650V 沟槽栅/场终止工艺
- 低开关损耗
- 正温度系数



典型应用:

- 充电桩
- OBC
- UPS
- 逆变器



$V_{CES} = 650V$, $I_{C\text{ nom}} = 50A$ / $I_{CRM} = 100A$

双极晶体管/IGBT

最大额定值 / Maximum Ratings

Parameter	Conditions	Symbol	Value		Unit
集电极-发射极电压 Collector-Emitter voltage	$T_{vj}=25^\circ C$	V_{CES}	650		V
连续集电极直流电流 Continuous DC collector current	$T_C=100^\circ C$, $T_{vj\text{ max}}=175^\circ C$	$I_{C\text{ nom}}$	50		A
集电极重复峰值电流 Repetitive peak collector current	$t_p=1\text{ ms}$	I_{CRM}	100		A
总功率损耗 Total power dissipation	$T_C = 25^\circ C$, $T_{vj\text{ max}} = 175^\circ C$	P_{tot}	275		W
栅极-发射极电压 Gate emitter voltage		V_{GE}	± 20		V

特征值 / Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
集电极-发射极饱和电压 Collector-Emitter saturation voltage	$V_{GE}=15V$, $I_c=50A$	V_{CEsat}		1.50	2.10	V
	$V_{GE}=15V$, $I_c=50A$			1.87		
	$V_{GE}=15V$, $I_c=50A$			1.95		
栅极-发射极阈值电压 Gate-Emitter threshold voltage	$I_c=0.5mA$, $V_{GE}=V_{CE}$	$V_{GE(th)}$	4.2	5.0	5.8	

跨导 Transconductance	V _{CE} =20V, I _C =50A	G _{fs}		77		S
输入电容 Input capacitance	f=1 MHz, V _{CE} =25 V, V _{GE} =0 V T _{vj} =25°C	C _{ies}		5.46		nF
反向传输电容 Reverse transfer capacitance		C _{res}		0.1		
集电极-发射极截止电流 Collector-emitter cut-off current	V _{CE} =650V , V _{GE} = 0 V T _{vj} =25°C	I _{CES}			1	mA
栅极-发射极漏电流 Gate-emitter leakage current	V _{CE} =0 V, V _{GE} = 20 V T _{vj} =25°C	I _{GES}			200	nA
开通延迟时间 Turn-on delay time	I _C =50A, V _{CE} =400 V T _{vj} =25°C V _{GE} =±15 V, R _G =8Ω T _{vj} =125°C (电感负载) / (inductive load) T _{vj} =150°C	t _{d on}		43		ns
上升时间 Rise time	I _C =50A, V _{CE} =400 V T _{vj} =25°C V _{GE} =±15 V, R _G =8Ω T _{vj} =125°C (电感负载) / (inductive load) T _{vj} =150°C	t _r		20		
关断延迟时间 Turn-off delay time	I _C =50A, V _{CE} =400 V T _{vj} =25°C V _{GE} =±15 V, R _G =8Ω T _{vj} =125°C (电感负载) / (inductive load) T _{vj} =150°C	t _{d off}		19		
下降时间 Fall time	I _C =50A, V _{CE} =400 V T _{vj} =25°C V _{GE} =±15 V, R _G =8Ω T _{vj} =125°C (电感负载) / (inductive load) T _{vj} =150°C	t _f		75		
开通损耗能量 (每脉冲) Turn-on energy loss per pulse	I _C =50A, V _{CE} =400 V T _{vj} =25°C V _{GE} =±15 V, R _G =8Ω T _{vj} =125°C (电感负载) / (inductive load) T _{vj} =150°C	E _{on}		1.86		mJ
关断损耗能量 (每脉冲) Turn-off energy loss per pulse	I _C =50A, V _{CE} =400 V T _{vj} =25°C V _{GE} =±15 V, R _G =8Ω T _{vj} =125°C (电感负载) / (inductive load) T _{vj} =150°C	E _{off}		1.86		
结-外壳热阻 IGBT thermal resistance, junction		R _{thJC}		0.64		
在开关状态下温度 Temperature under switching conditions		T _{vj op}	-40	0.38	175	°C

二极管/Diode

最大额定值 / Maximum Ratings

Parameter	Conditions	Symbol	Value	Unit
反向重复峰值电压 Repetitive peak reverse voltage	T _{vj} =25°C	V _{RRM}	650	V
连续正向直流电流 Continuous DC forward current	T _C =100°C, T _{vj max} =175°C	I _F	50	A
正向重复峰值电流 Repetitive peak forward current	t _p =1ms	I _{FRM}	100	A

特征值 / Characteristic Values

Parameter	Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
正向电压 Forward voltage	I _F =50A, V _{GE} =0V I _F =50A, V _{GE} =0V I _F =50A, V _{GE} =0V	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	V _F	1.33 1.20 1.17	1.9	V
反向恢复峰值电流 Peak reverse recovery current	I _F =50A, -di _F /dt=387A/μs(T _{vj} =150°C) V _R =400V, V _{GE} =-15V	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	I _{RM}	26 37 42		A
反向恢复电荷 Reverse Recovered charge	I _F =50A, -di _F /dt=387A/μs(T _{vj} =150°C) V _R =400V, V _{GE} =-15V	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	Q _{rr}	2.12 4.65 5.66		μC
反向恢复时间 Reverse Recovery Time	I _F =50A, -di _F /dt=387A/μs(T _{vj} =150°C) V _R =400V, V _{GE} =-15V	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	t _{rr}	164 231 247		ns
反向恢复损耗 (每脉冲) Reverse recovered energy	I _F =50A, -di _F /dt=387A/μs(T _{vj} =150°C) V _R =400V, V _{GE} =-15V	T _{vj} =25°C T _{vj} =125°C T _{vj} =150°C	E _{rec}	0.65 0.88 0.95		mJ
结-外壳热阻 Diode thermal resistance, junction		R _{thJC}		0.45		K/W
在开关状态下温度 Temperature under switching conditions		T _{vj op}	-40		175	°C

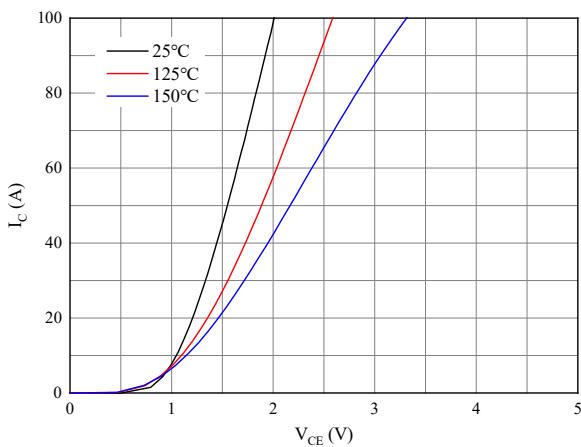


图 1. 典型输出特性 ($V_{GE}=15V$)

Figure 1. Typical output characteristics ($V_{GE}=15V$)

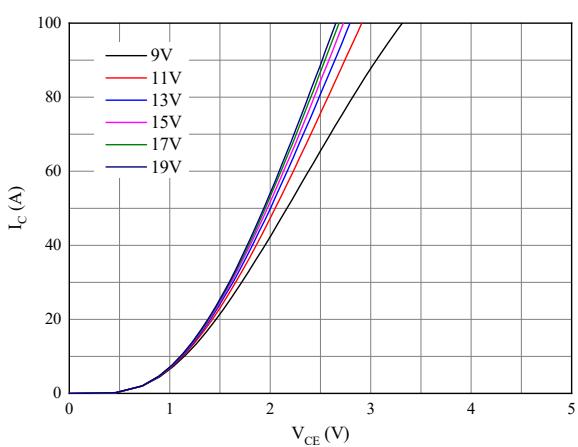


图 2. 典型输出特性 ($T_{vj}=150^{\circ}C$)

Figure 2. Typical output characteristics ($T_{vj}=150^{\circ}C$)

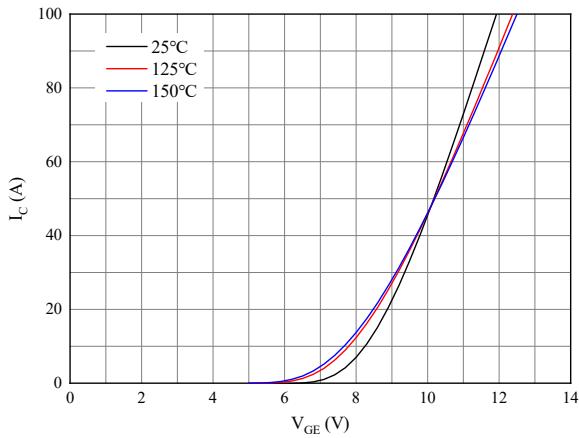


图 3. 典型传输特性($V_{CE}=20V$)

Figure 3. Typical transfer characteristic($V_{CE}=20V$)

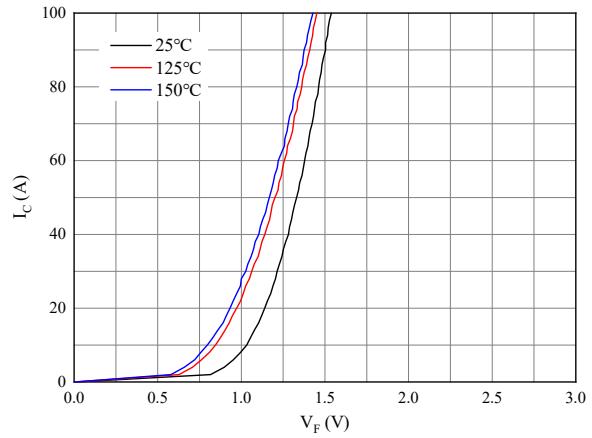


图 4. 正向偏压特性 二极管

Figure 4. Forward characteristic of Diode

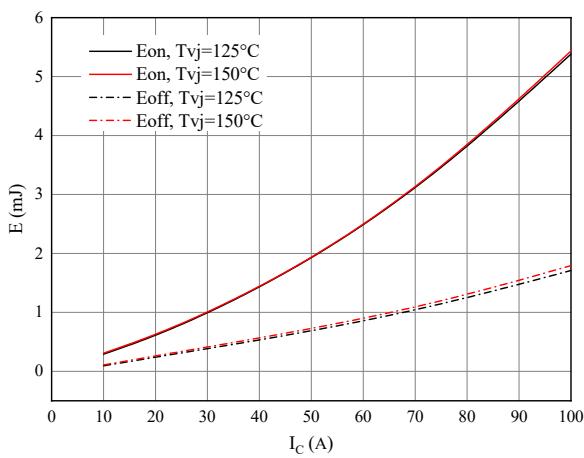


图 5. 开关损耗

Figure 5. Switching losses of IGBT

$V_{GE}=\pm 15V$, $R_{Gon}=8\Omega$, $R_{goff}=8\Omega$, $V_{CE}=400V$

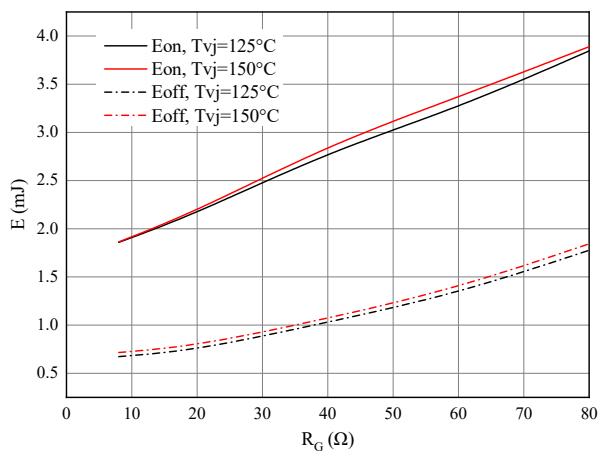


图 6. 开关损耗

Figure 6. Switching losses of IGBT

$V_{GE}=\pm 15V$, $I_C=50A$, $V_{CE}=400V$

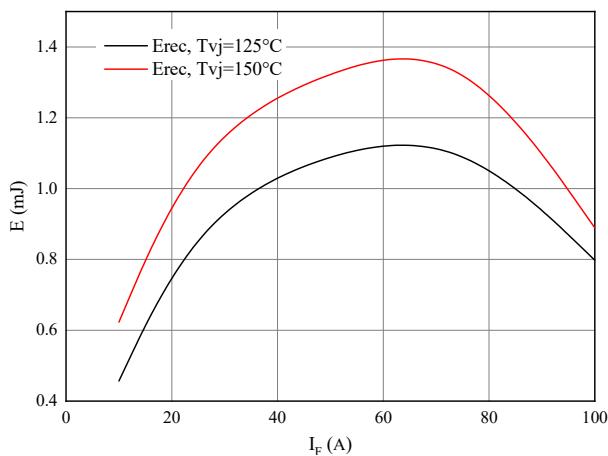


图 7. 开关损耗 二极管

Figure 7. Switching losses of Diode

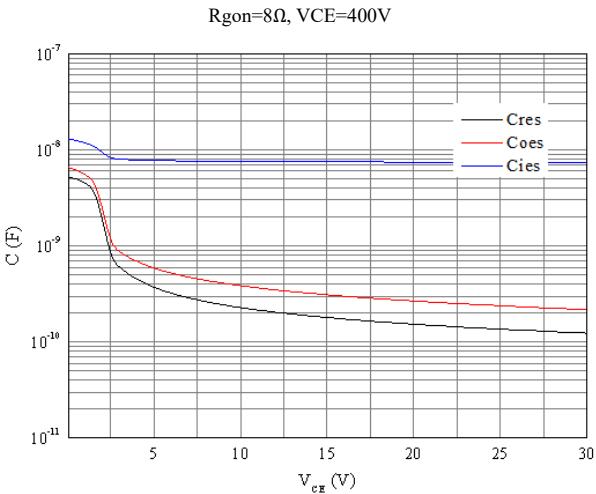


图 9. 电容特性

Figure 9. Capacitance characteristic

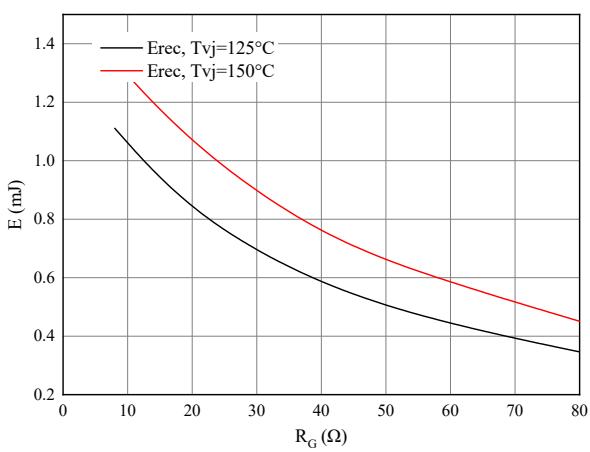
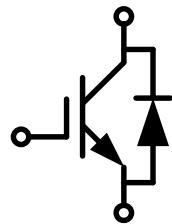


图 8. 开关损耗 二极管

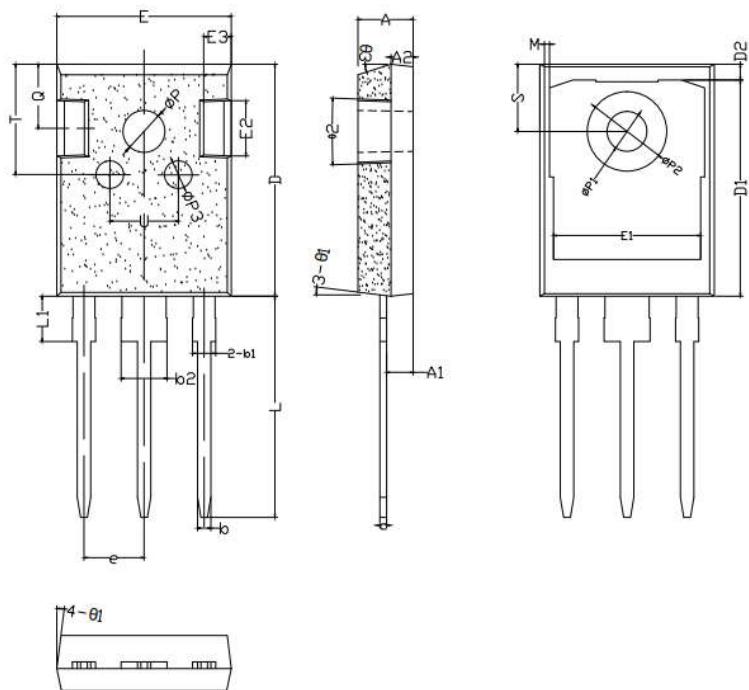
Figure 8. Switching losses of Diode

IF=50A, VCE=400V

接线图 / Circuit diagram



封装尺寸 / Package outlines



SYMBOL	mm		
	MIN	NOM	MAX
*A	4.90	5.00	5.10
*A1	2.31	2.41	2.51
A2	1.90	2.00	2.10
*b	1.15	1.20	1.25
*b1	1.95	2.10	2.25
*b2	2.95	3.10	3.25
*c	0.55	0.60	0.65
*D	20.90	21.00	21.10
D1	16.35	16.55	16.75
D2	1.05	1.20	1.35
*E	15.70	15.80	15.90
E1	13.10	13.25	13.40
E2	4.90	5.00	5.10
E3	2.40	2.50	2.60
*e	5.40	5.44	5.48
*L	19.80	19.92	20.10
*L1	-	-	4.30
*ΦP	3.70	3.80	3.90
*ΦP1	3.50	3.60	3.70
ΦP2	7.00	7.20	7.40
ΦP3	2.40	2.50	2.60
Q	5.60	5.80	6.00
*S	6.05	6.15	6.25
T	9.80	10.00	10.20
U	6.00	6.20	6.40
θ1	5*	7*	9*
θ2	1*	3*	5*
θ3	13*	15*	17*